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PATENT APPLICATION

AP 1733

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

#6/1/2002
10/16/02

In re application of

Docket No: Q62228

Yoshihisa FURUTA, et al.

Appln. No.: 09/719,422

Group Art Unit: 1733

Confirmation No.: 7788

Examiner: Barbara J. MUSSER

Filed: December 12, 2000

For: METHOD OF RESIN ENCAPSULATING SEMICONDUCTOR CHIP AND
PRESSURE-SENSITIVE ADHESIVE TAPE FOR ADHESION TO LEADFRAME AND
THE LIKE

PETITION FOR EXTENSION OF TIME UNDER 37 C.F.R. § 1.136

Commissioner for Patents
Washington, D.C. 20231

Sir:

Pursuant to 37 C.F.R. § 1.136, Applicants hereby petition for an extension of time of one month, extending the time for responding to the Office Action of June 5, 2002 to October 7, 2002. (October 5, 2002 fell on a weekend.)

A check for the statutory fee of \$110.00 is attached. The USPTO is directed and authorized to charge any additional required fees, except for the Issue Fee and the Publication Fee, to Deposit Account No. 19-4880. Please also credit any overpayments to said Deposit Account. A duplicate copy of this sheet is enclosed.

10/09/2002 DTESSEH1 00000073 09719422

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110.00 OP

Respectfully submitted,

Mark Boland

Registration No. 32,197

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Date: October 7, 2002